



■ 14A, 650V, $R_{DS(on)(Typ)} = 0.6\Omega$ @ $V_{GS} = 10V$

■ Low Gate Charge

■ Low C_{rss}

■ 100% Avalanche Tested

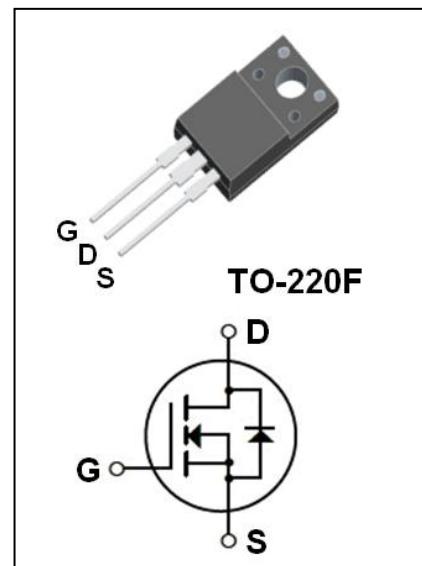
■ Fast Switching

■ Improved dv/dt Capability

● **Application:**

■ High Frequency Switching Mode Power Supply

■ Active Power Factor Correction



Absolute Maximum Ratings ($T_c = 25^\circ C$ unless otherwise noted)

Symbol	Parameter		Value	Unit	
V_{DSS}	Drain-Source Voltage		650	V	
I_D	Drain Current	- Continuous ($T_c = 25^\circ C$)	14*	A	
		- Continuous ($T_c = 100^\circ C$)	8.6*	A	
I_{DM}	Drain Current	-Pulsed	(Note1)	56*	A
V_{GSS}	Gate-Source Voltage		± 30	V	
E_{AS}	Single Pulsed Avalanche Energy		940	mJ	
I_{AR}	Avalanche Current		14.0	A	
E_{AR}	Repetitive Avalanche Energy		28	mJ	
dv/dt	Peak Diode Recovery dv/dt		4.5	V/ns	
P_D	Power Dissipation ($T_c = 25^\circ C$)		54	W	
	-Derate above $25^\circ C$		0.43	W/ $^\circ C$	
T_j	Operating Junction Temperature		150	$^\circ C$	
T_{stg}	Storage Temperature Range		-55 to +150	$^\circ C$	

* Drain Current Limited by Maximum Junction Temperature.

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.31	$^\circ C / W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	$^\circ C / W$

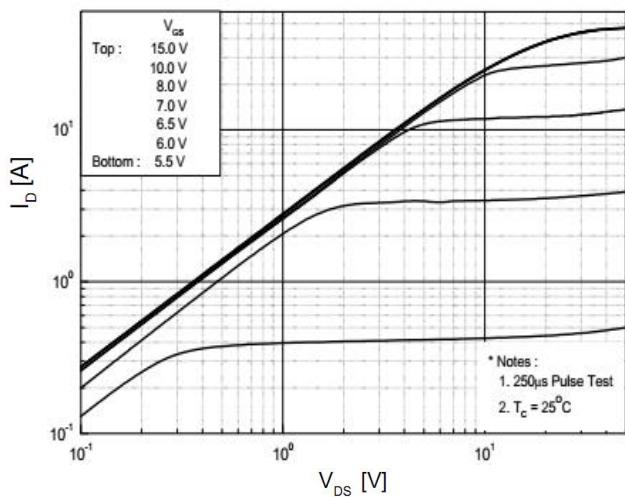
Electrical Characteristics(Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditons	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain-source Breakdown Voltage	V _{GS} =0V , I _D =250μA	650	--	--	V
△BV _{DSS} /△T _J	Breakdown Voltage Temperature Coefficient	I _D =250μA (Referenced to 25°C)	--	0.65	--	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =650V, V _{GS} =0V	--	--	1	μA
		V _{DS} =520V, Tc=125°C	--	--	10	μA
I _{GSSF}	Gate-Body Leakage Current,Forward	V _{GS} =+30V, V _{DS} =0V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current,Reverse	V _{GS} =-30V, V _{DS} =0V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250μA	2.0	--	4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10 V, I _D =7.0A	--	0.6	0.75	Ω
g _{FS}	Forward Transconductance	V _{DS} =40 V, I _D =7.0A (Note4)	--	9.0	--	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	--	2150	--	pF
C _{oss}	Output Capacitance		--	255	--	pF
C _{rss}	Reverse Transfer Capacitance		--	22.5	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 325 V, I _D = 14 A, R _G = 25 Ω (Note4,5)	--	55	--	ns
t _r	Turn-On Rise Time		--	100	--	ns
t _{d(off)}	Turn-Off Delay Time		--	115	--	ns
t _f	Turn-Off Fall Time		--	75.0	--	ns
Q _g	Total Gate Charge	V _{DS} = 520 V, I _D =14.0 A, V _{GS} = 10 V (Note4,5)	--	49	--	nC
Q _{gs}	Gate-Source Charge		--	12	--	nC
Q _{gd}	Gate-Drain Charge		--	22	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current	--	--	14	--	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	56	--	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} =0V,I _S =14.0A	--	--	1.3	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V, I _S =14.0A, d I _F /dt=100A/μs (Note4)	--	480	--	ns
Q _{rr}	Reverse Recovery Charge		--	5.25	--	μC

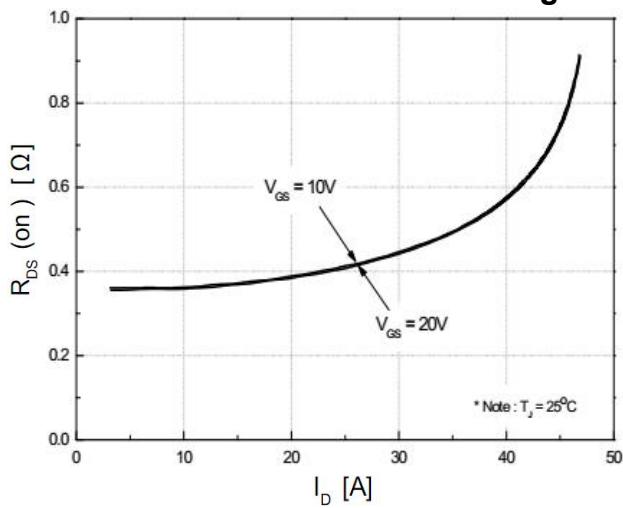
Notes:

- 1、Repetitive Rating:Pulse Width Limited by Maximum Junction Temperature.
- 2、L = 10mH, I_{AS} =14.0A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C.
- 3、I_{SD}≤14.0A, di/dt≤200A/μs, V_{DD}≤BV_{DSS}, Starting T_J = 25°C.
- 4、Pulse Test : Pulse Width ≤300 μ s, Duty Cycles≤2%.
- 5、Essentially Independent of Operating Temperature.

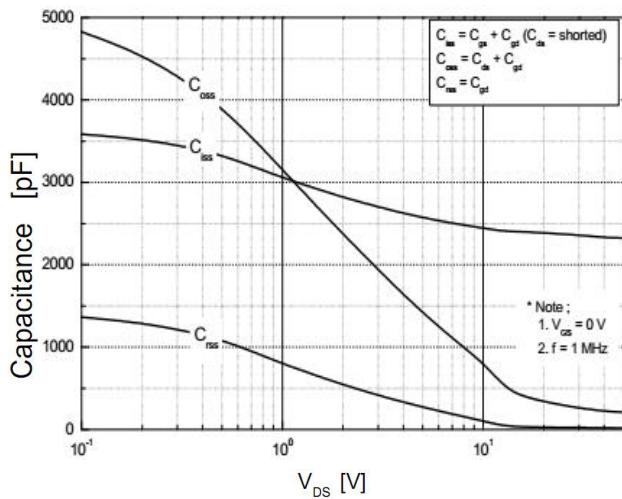
On-Region Characteristics



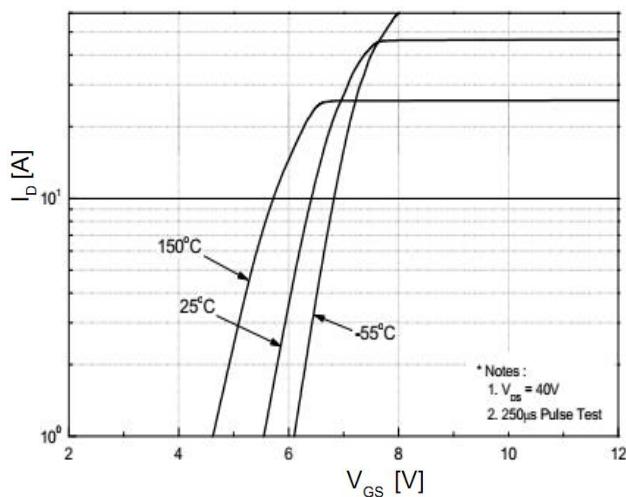
On-Resistance Variation vs.
Drain Current and Gate Voltage



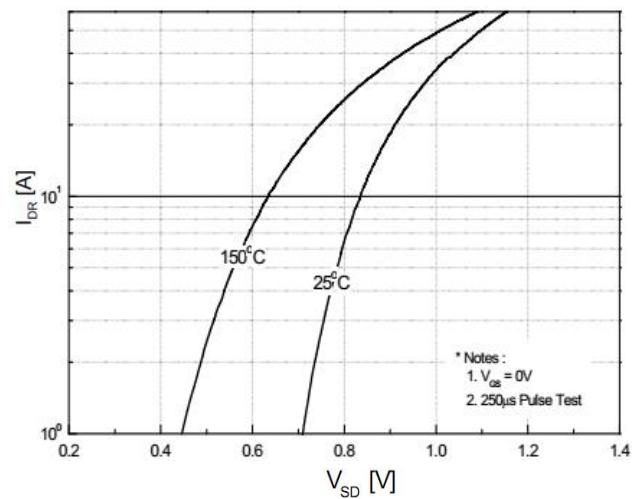
Capacitance Characteristics



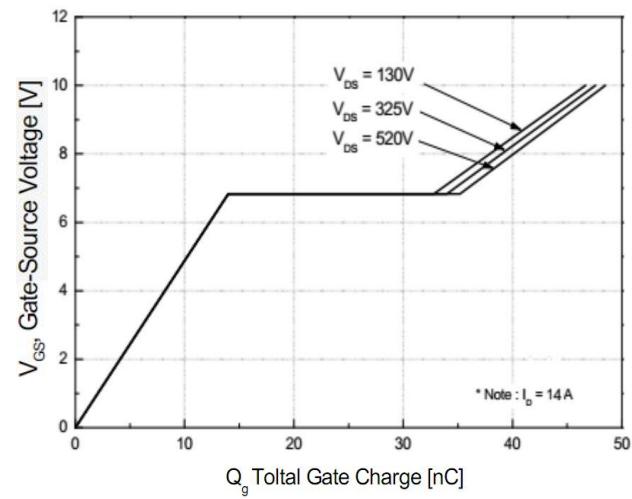
Transfer Characteristics



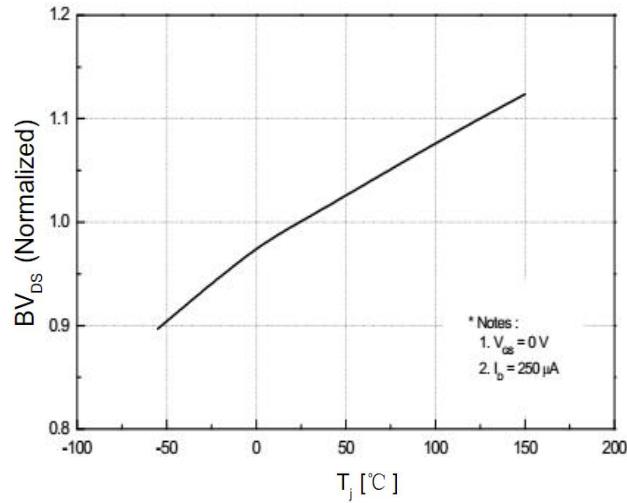
Body Diode Forward Voltage Variation
vs. Source Current and Temperature



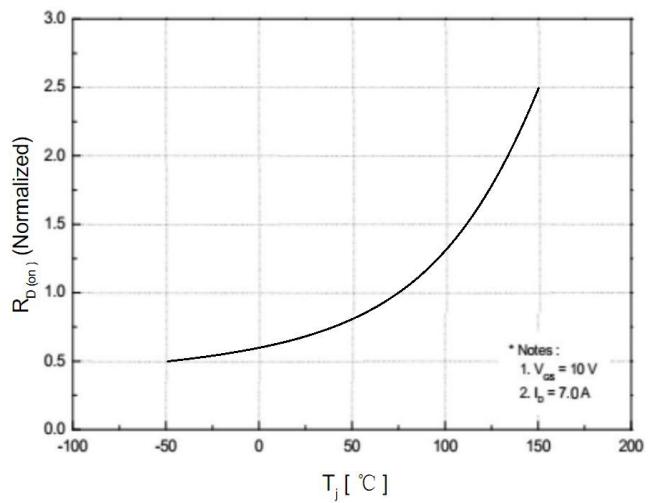
Gate Charge Characteristics



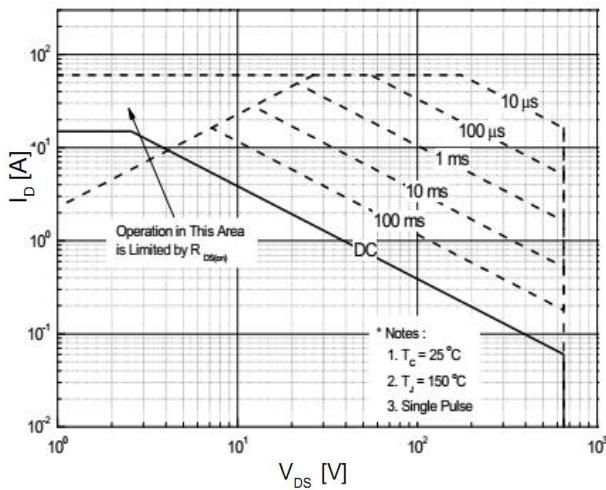
Breakdown Voltage Variation vs. Temperature



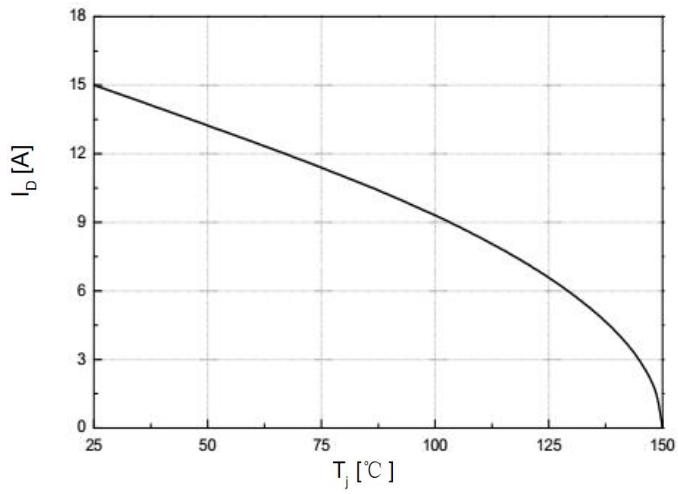
On-Resistance Variation vs. Temperature



Maximum Safe Operating Area



Maximum Drain Current Vs. Case Temperature



TO-220F Package Dimensions

UNIT: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	9.80		10.60	D		2.54	
A1		7.00		D1	1.15		1.55
A2	2.90		3.40	D2	0.60		1.00
A3	9.10		9.90	D3	0.20		0.50
B1	15.40		16.40	E	2.24		2.84
B2	4.35		4.95	E1		0.70	
B3	6.00		7.40	E2		$1.0 \times 45^\circ$	
C	3.00		3.70	E3	0.35		0.65
C1	15.00		17.00	E4	2.30		3.30
C2	8.80		10.80	α (度)		30°	

